

FEATURES

- **Low Power: $I_{CC} = 120\mu\text{A}$ Max with Driver Disabled**
- $I_{CC} = 500\mu\text{A}$ Max with Driver Enabled, No Load
- **$1\mu\text{A}$ Quiescent Current in Shutdown Mode**
- Controlled Slew Rate Driver for Reduced EMI
- Single 5V Supply
- **Drivers/Receivers Have $\pm 10\text{kV}$ ESD Protection**
- -7V to 12V Common-Mode Range Permits $\pm 7\text{V}$ Ground Difference Between Devices on the Data Line
- Thermal Shutdown Protection
- Power Up/Down Glitch-Free Driver Outputs Permit Live Insertion or Removal of Transceiver
- Driver Maintains High Impedance in Three-State or with the Power Off
- Up to 32 Transceivers on the Bus
- Pin Compatible with the LTC485

APPLICATIONS

- Battery-Powered RS485/RS422 Applications
- Low Power RS485/RS422 Transceiver
- Level Translator

DESCRIPTION

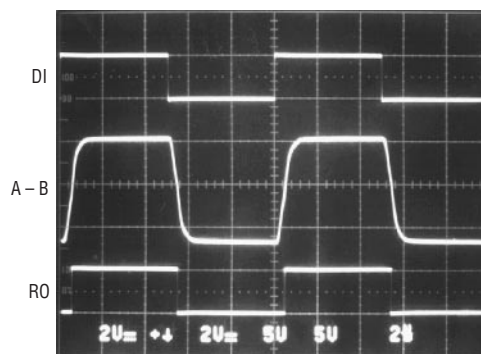
The LTC[®]1483 is an ultra-low power differential line transceiver designed for data transmission standard RS485 applications with extended common-mode range (-7V to 12V). It will also meet the requirements of RS422. The LTC1483 features output drivers with controlled slew rate, decreasing the EMI radiated from the RS485 lines, and improving signal fidelity with misterminated lines. The CMOS design offers significant power savings over its bipolar counterparts without sacrificing ruggedness against overload or ESD damage. Typical quiescent current is only $80\mu\text{A}$ while operating and less than $1\mu\text{A}$ in shutdown.

The driver and receiver feature three-state outputs, with the driver outputs maintaining high impedance over the entire common-mode range. Excessive power dissipation caused by bus contention or faults is prevented by a thermal shutdown circuit which forces the driver outputs into a high impedance state. The receiver has a fail-safe feature which guarantees a high output state when the inputs are left open. I/O pins are protected against multiple ESD strikes of over $\pm 10\text{kV}$.

The LTC1483 is fully specified over the commercial and extended industrial temperature range and is available in 8-pin DIP and SO packages.

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TYPICAL APPLICATION



ABSOLUTE MAXIMUM RATINGS

(Note 1)

| | |
|--|--|
| Supply Voltage (V_{CC}) | 12V |
| Control Input Voltage | -0.5V to $V_{CC} + 0.5V$ |
| Driver Input Voltage | -0.5V to $V_{CC} + 0.5V$ |
| Driver Output Voltage | $\pm 14V$ |
| Receiver Input Voltage | $\pm 14V$ |
| Receiver Output Voltage | -0.5V to $V_{CC} + 0.5V$ |
| Operating Temperature Range | |
| LTC1483C | $0^{\circ}C \leq T_A \leq 70^{\circ}C$ |
| LTC1483I | $-40^{\circ}C \leq T_A \leq 85^{\circ}C$ |
| Storage Temperature Range | $-65^{\circ}C$ to $150^{\circ}C$ |
| Lead Temperature (Soldering, 10 sec) | $300^{\circ}C$ |

PACKAGE/ORDER INFORMATION

| | |
|---|--|
| <p>N8 PACKAGE 8-LEAD PDIP</p> <p>S8 PACKAGE 8-LEAD PLASTIC SO</p> <p>$T_{JMAX} = 125^{\circ}C, \theta_{JA} = 130^{\circ}C/W$ (N8) $T_{JMAX} = 125^{\circ}C, \theta_{JA} = 150^{\circ}C/W$ (S8)</p> | ORDER PART NUMBER |
| | LTC1483CN8 LTC1483IN8 LTC1483CS8 LTC1483IS8 |
| | S8 PART MARKING |
| | 1483 1483I |

Consult factory for Military grade parts.

ELECTRICAL CHARACTERISTICS

$V_{CC} = 5V$, (Notes 2, 3) unless otherwise noted.

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|-------------------|---|--|--------|-----------|-------------|--------------------|
| V_{OD1} | Differential Driver Output Voltage (Unloaded) | $I_O = 0$ | ● | | 5 | V |
| V_{OD2} | Differential Driver Output Voltage (with Load) | $R = 50\Omega$ (RS422) $R = 27\Omega$ (RS485), Figure 1 | ● ● | 2 1.5 | 5 | V V |
| ΔV_{OD} | Change in Magnitude of Driver Differential Output Voltage for Complementary Output States | $R = 27\Omega$ or $R = 50\Omega$, Figure 1 | ● | | 0.2 | V |
| V_{OC} | Driver Common-Mode Output Voltage | $R = 27\Omega$ or $R = 50\Omega$, Figure 1 | ● | | 3 | V |
| $\Delta V_{OC} $ | Change in Magnitude of Driver Common-Mode Output Voltage for Complementary Output States | $R = 27\Omega$ or $R = 50\Omega$, Figure 1 | ● | | 0.2 | V |
| V_{IH} | Input High Voltage | DE, DI, \overline{RE} | ● | 2 | | V |
| V_{IL} | Input Low Voltage | DE, DI, \overline{RE} | ● | | 0.8 | V |
| I_{IN1} | Input Current | DE, DI, \overline{RE} | ● | | ± 2 | μA |
| I_{IN2} | Input Current (A, B) | DE = 0, $V_{CC} = 0V$ or $5.25V$, $V_{IN} = 12V$ DE = 0, $V_{CC} = 0V$ or $5.25V$, $V_{IN} = -7V$ | ● ● | | 1.0 -0.8 | mA mA |
| V_{TH} | Differential Input Threshold Voltage for Receiver | $-7V \leq V_{CM} \leq 12V$ | ● | -0.2 | 0.2 | V |
| ΔV_{TH} | Receiver Input Hysteresis | $V_{CM} = 0V$ | ● | 45 | | mV |
| V_{OH} | Receiver Output High Voltage | $I_O = -4mA$, $V_{ID} = 200mV$ | ● | 3.5 | | V |
| V_{OL} | Receiver Output Low Voltage | $I_O = 4mA$, $V_{ID} = -200mV$ | ● | | 0.4 | V |
| I_{OZR} | Three-State (High Impedance) Output Current at Receiver | $V_{CC} = \text{Max}$, $0.4V \leq V_O \leq 2.4V$ | ● | | ± 1 | μA |
| R_{IN} | Receiver Input Resistance | $-7V \leq V_{CM} \leq 12V$ | ● | 12 | 25 | k Ω |
| I_{CC} | Supply Current | No Load, Output Enabled No Load, Output Disabled | ● ● | 300 80 | 500 120 | μA μA |
| I_{SHDN} | Supply Current in Shutdown Mode | DE = 0, $\overline{RE} = V_{CC}$ | | 1 | 10 | μA |
| I_{OSD1} | Driver Short-Circuit Current, $V_{OUT} = \text{HIGH}$ | $-7V \leq V_O \leq 12V$ | ● | 35 | 250 | mA |
| I_{OSD2} | Driver Short-Circuit Current, $V_{OUT} = \text{LOW}$ | $-7V \leq V_O \leq 12V$ | ● | 35 | 250 | mA |
| I_{OSR} | Receiver Short-Circuit Current | $0V \leq V_O \leq V_{CC}$ | ● | 7 | 85 | mA |

SWITCHING CHARACTERISTICS V_{CC} = 5V, (Notes 2, 3) unless otherwise noted.

| SYMBOL | PARAMETER | CONDITIONS | LTC1483 | | | UNITS | |
|---------------------------------|--|---|---------|-----|------|---------|----|
| | | | MIN | TYP | MAX | | |
| t _{PLH} | Driver Input to Output | R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF, (Figures 3, 5) | ● | 150 | 1200 | ns | |
| t _{PHL} | Driver Input to Output | | ● | 150 | 1200 | ns | |
| t _{SKEW} | Driver Output to Output | | ● | | 100 | 600 | ns |
| t _r , t _f | Driver Rise or Fall Time | | ● | 150 | | 1200 | ns |
| t _{ZH} | Driver Enable to Output High | C _L = 100pF (Figures 4, 6), S2 Closed | ● | 100 | 1500 | ns | |
| t _{ZL} | Driver Enable to Output Low | C _L = 100pF (Figures 4, 6), S1 Closed | ● | 100 | 1500 | ns | |
| t _{LZ} | Driver Disable Time from Low | C _L = 15pF (Figures 4, 6), S1 Closed | ● | 150 | 1500 | ns | |
| t _{HZ} | Driver Disable Time from High | C _L = 15pF (Figures 4, 6), S2 Closed | ● | 150 | 1500 | ns | |
| t _{PLH} | Receiver Input to Output | R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF, (Figures 3, 7) | ● | 30 | 140 | 200 | ns |
| t _{PHL} | Receiver Input to Output | | ● | 30 | 140 | 200 | ns |
| t _{SKD} | t _{PLH} - t _{PHL} Differential Receiver Skew | | ● | | 13 | | ns |
| t _{ZL} | Receiver Enable to Output Low | C _{RL} = 15pF (Figures 2, 8), S1 Closed | ● | | 20 | 50 | ns |
| t _{ZH} | Receiver Enable to Output High | C _{RL} = 15pF (Figures 2, 8), S2 Closed | ● | | 20 | 50 | ns |
| t _{LZ} | Receiver Disable from Low | C _{RL} = 15pF (Figures 2, 8), S1 Closed | ● | | 20 | 50 | ns |
| t _{HZ} | Receiver Disable from High | C _{RL} = 15pF (Figures 2, 8), S2 Closed | ● | | 20 | 50 | ns |
| f _{MAX} | Maximum Data Rate | | ● | 250 | | kbits/s | |
| t _{SHDN} | Time to Shutdown | DE = 0, RE = \bar{L} | ● | 50 | 200 | 600 | ns |
| t _{ZH(SHDN)} | Driver Enable from Shutdown to Output High | C _L = 100pF (Figures 4, 6), S2 Closed | ● | | | 2000 | ns |
| t _{ZL(SHDN)} | Driver Enable from Shutdown to Output Low | C _L = 100pF (Figures 4, 6), S1 Closed | ● | | | 2000 | ns |
| t _{ZH(SHDN)} | Receiver Enable from Shutdown to Output High | C _L = 15pF (Figures 2, 8), S2 Closed | ● | | | 3500 | ns |
| t _{ZL(SHDN)} | Receiver Enable from Shutdown to Output Low | C _L = 15pF (Figures 2, 8), S1 Closed | ● | | | 3500 | ns |

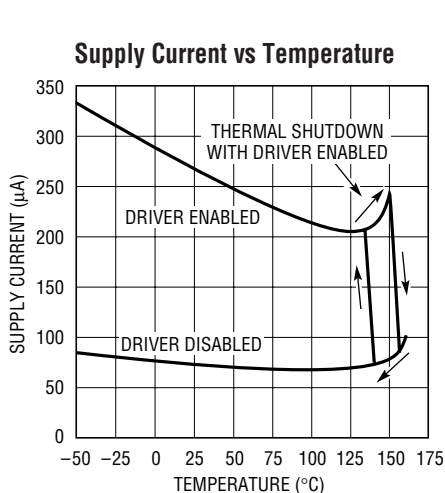
The ● denotes specifications which apply over the full operating temperature range.

Note 1: Absolute maximum ratings are those beyond which the safety of the device cannot be guaranteed.

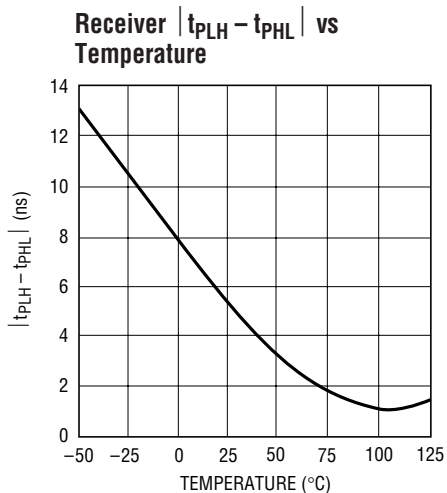
Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

Note 3: All typicals are given for V_{CC} = 5V and T_A = 25°C.

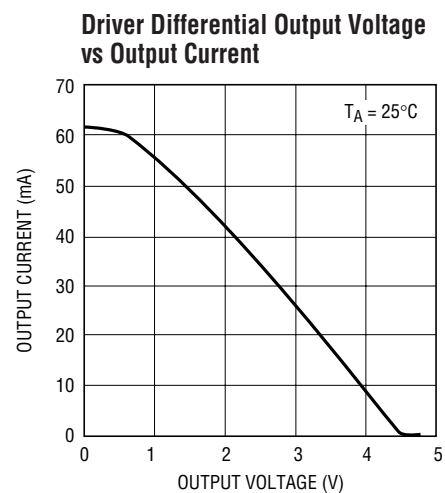
TYPICAL PERFORMANCE CHARACTERISTICS



1483 G01



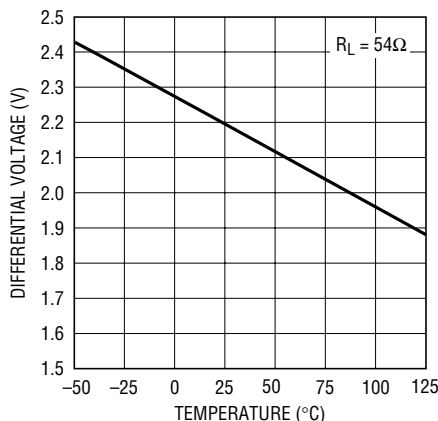
1483 G02



1483 G03
sn1483 1483is

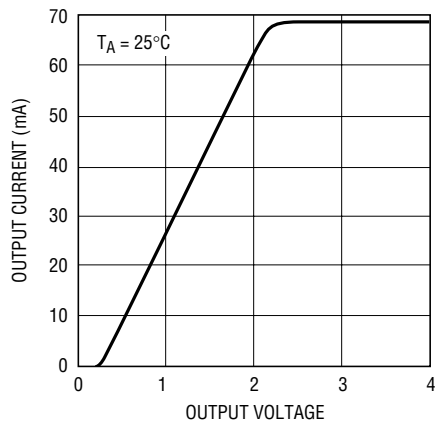
TYPICAL PERFORMANCE CHARACTERISTICS

Driver Differential Output Voltage vs Temperature



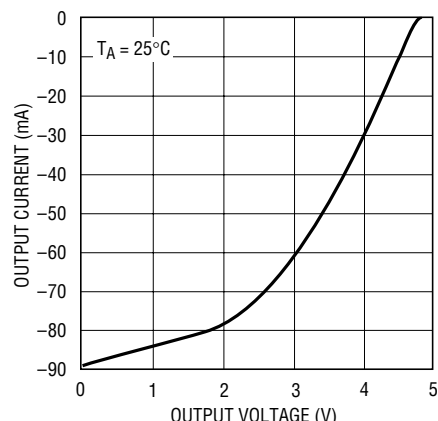
1483 G04

Driver Output Low Voltage vs Output Current



1483 G05

Driver Output High Voltage vs Output Current



1483 G06

PIN FUNCTIONS

RO (Pin 1): Receiver Output. If the receiver output is enabled (\overline{RE} low), then if $A > B$ by 200mV, RO will be high. If $A < B$ by 200mV, then RO will be low.

\overline{RE} (Pin 2): Receiver Output Enable. A low enables the receiver output, RO. A high input forces the receiver output into a high impedance state.

DE (Pin 3): Driver Outputs Enable. A high on DE enables the driver output. A, B and the chip will function as a line driver. A low input will force the driver outputs into a high impedance state and the chip will function as a line receiver. If \overline{RE} is high and DE is low, the part will enter a low power ($1\mu A$) shutdown state.

DI (Pin 4): Driver Input. If the driver outputs are enabled (DE high) then a low on DI forces the outputs A low and B high. A high on DI with the driver outputs enabled will force A high and B low.

GND (Pin 5): Ground.

A (Pin 6): Driver Output/Receiver Input.

B (Pin 7): Driver Output/Receiver Input.

V_{CC} (Pin 8): Positive Supply. $4.75V < V_{CC} < 5.25V$.

FUNCTION TABLES

LTC1483 Transmitting

| INPUTS | | | OUTPUTS | |
|-----------------|----|----|---------|----|
| \overline{RE} | DE | DI | B | A |
| X | 1 | 1 | 0 | 1 |
| X | 1 | 0 | 1 | 0 |
| 0 | 0 | X | Z | Z |
| 1 | 0 | X | Z* | Z* |

*Shutdown mode for LTC1483

LTC1483 Receiving

| INPUTS | | | OUTPUTS |
|-----------------|----|--------------|---------|
| \overline{RE} | DE | A - B | RO |
| 0 | 0 | $\geq 0.2V$ | 1 |
| 0 | 0 | $\leq -0.2V$ | 0 |
| 0 | 0 | Inputs Open | 1 |
| 1 | 0 | X | Z* |

*Shutdown mode for LTC1483

TEST CIRCUITS



Figure 1. Driver DC Test Load



Figure 2. Receiver Timing Test Load



Figure 3. Driver/Receiver Timing Test Circuit



Figure 4. Driver Timing Test Load

SWITCHING TIME WAVEFORMS



Figure 5. Driver Propagation Delays

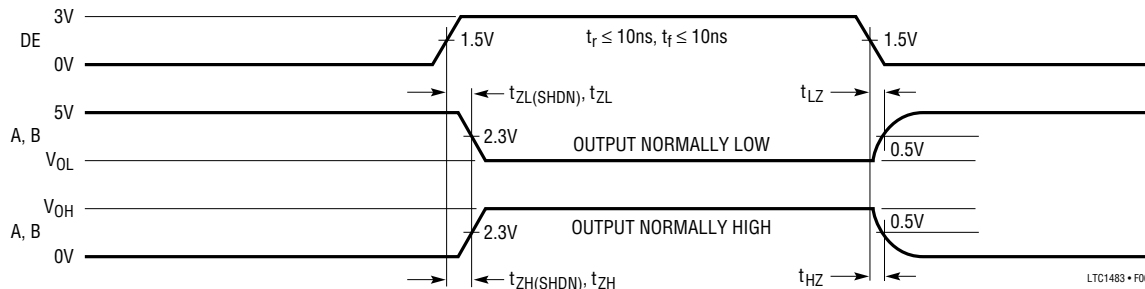


Figure 6. Driver Enable and Disable Times

SWITCHING TIME WAVEFORMS



Figure 7. Receiver Propagation Delays

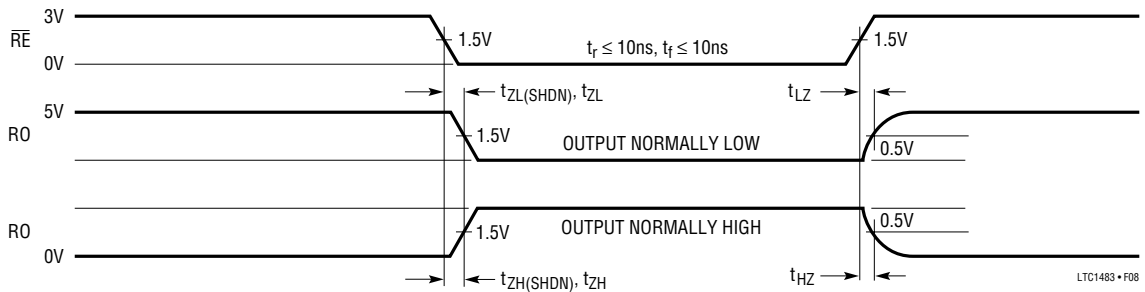


Figure 8. Receiver Enable and Disable Times

APPLICATIONS INFORMATION

Basic Theory of Operation

Traditionally RS485 transceivers have been designed using bipolar technology because the common-mode range of the device must extend beyond the supplies and the device must be immune to ESD damage and latch-up. Unfortunately, most bipolar devices draw a large amount of supply current, which is unacceptable for the numerous applications that require low power consumption. The LTC1483 is a CMOS RS485/RS422 transceiver which features ultra-low power consumption without sacrificing ESD and latch-up immunity.

The LTC1483 uses a proprietary driver output stage, which allows a common-mode range that extends beyond the power supplies while virtually eliminating latch-up and providing excellent ESD protection. Figure 9 shows the LTC1483 output stage while Figure 10 shows a conventional CMOS output stage.

When the conventional CMOS output stage of Figure 10 enters a high impedance state, both the P-channel (P1) and the N-channel (N1) are turned off. If the output is then driven above V_{CC} or below ground, the P+/N-well diode

(D1) or the N+/P-substrate diode (D2) respectively will turn on and clamp the output to the supply. Thus, the output stage is no longer in a high impedance state and is not able to meet the RS485 common-mode range requirement. In addition, the large amount of current flowing through either diode will induce the well-known CMOS latch-up condition, which could destroy the device.



Figure 9. LTC1483 Output Stage



Figure 10. Conventional CMOS Output Stage

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APPLICATIONS INFORMATION

The LTC1483 output stage of Figure 9 eliminates these problems by adding two Schottky diodes, SD3 and SD4. The Schottky diodes are fabricated by a proprietary modification to the standard N-well CMOS process. When the output stage is operating normally, the Schottky diodes are forward biased and have a small voltage drop across them. When the output is in the high impedance state and is driven above V_{CC} or below ground, the parasitic diode D1 or D2 still turns on, but SD3 or SD4 will reverse bias and prevent current from flowing into the N-well or the substrate. Thus the high impedance state is maintained even with the output voltage beyond the supplies. With no minority carrier current flowing into the N-well or substrate, latch-up is virtually eliminated under power-up or power-down conditions.

The LTC1483 output stage will maintain a high impedance state until the breakdown of the N-channel or P-channel is reached when going positive or negative respectively. The output will be clamped to either V_{CC} or ground by a Zener voltage plus a Schottky diode drop, but this voltage is well beyond the RS485 operating range. An ESD cell protects output against multiple $\pm 10\text{kV}$ human body model ESD strikes. Because the ESD injected current in the N-well or substrate consists of majority carriers, latch-up is prevented by careful layout techniques.

Slew Rate

The LTC1483 is designed for systems that are sensitive to electromagnetic radiation. The part features a slew rate limited driver that reduces high frequency electromagnetic emissions, while improving signal fidelity by reducing reflections due to misterminated cables. Figures 11 and 12 show the spectrum of the signal at the driver output for a standard slew rate RS485 driver and the slew rate limited LTC1483. The LTC1483 shows significant reduction of the high frequency harmonics. Because the driver is slew rate limited, the maximum operating frequency is limited to 250kbits/s.

Low Power Operation

The LTC1483 is designed to operate with a quiescent current of $120\mu\text{A}$ max. With the driver in three-state I_{CC} will

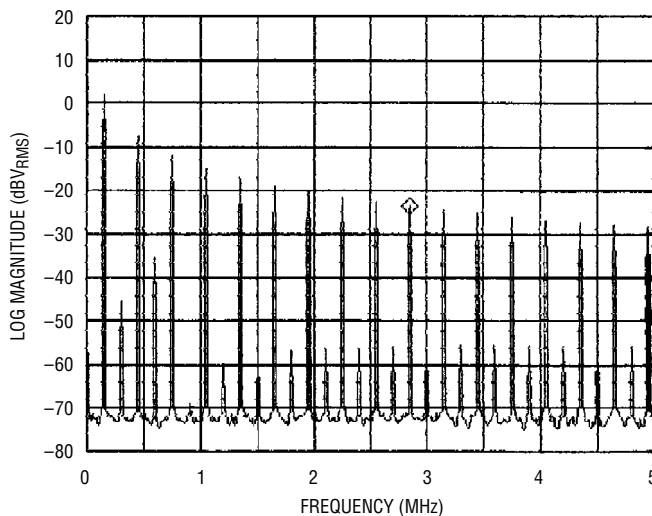


Figure 11. Typical RS485 Driver Output Spectrum Transmitting at 150kHz

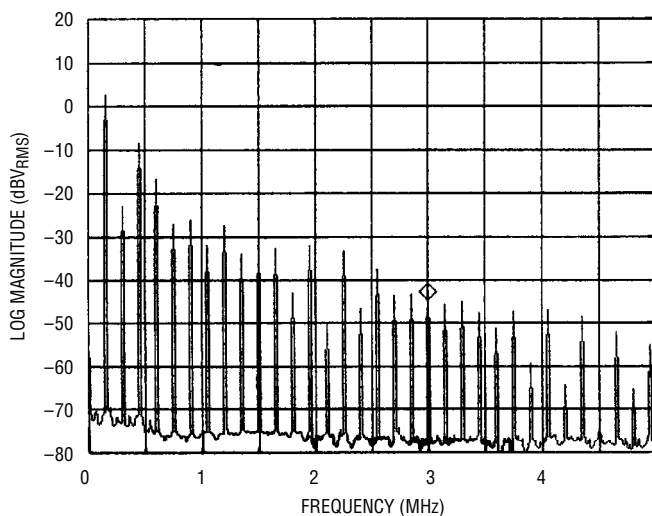


Figure 12. Slew Rate Limited LTC1483 Driver Output Spectrum Transmitting at 150kHz

drop to this $120\mu\text{A}$ level. With the driver enabled there will be additional current drawn by the internal 12k resistor. Under normal operating conditions this additional current is overshadowed by the current drawn by the external bus impedance.

APPLICATIONS INFORMATION

Shutdown Mode

Both the receiver output (RO) and the driver outputs (A, B) can be placed in three-state mode by bringing \overline{RE} high and DE low respectively. In addition, the LTC1483 will enter shutdown mode when \overline{RE} is high and DE is low.

In shutdown the LTC1483 typically draws only $1\mu\text{A}$ of supply current. In order to guarantee that the part goes into shutdown, \overline{RE} must be high and DE must be low for at least 600ns simultaneously. If this time duration is less

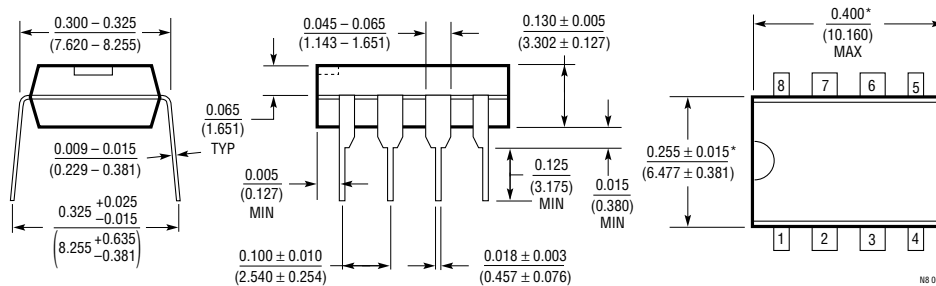
than 50ns the part will not enter shutdown mode. Toggling either \overline{RE} or DE will wake the LTC1483 back up within $3.5\mu\text{s}$.

If the slow slew rate driver was active immediately prior to shutdown, the supply current will not drop to $1\mu\text{A}$ until the driver outputs have reached a steady state; this can take as long as $2.6\mu\text{s}$ under worst case conditions. If the driver was disabled prior to shutdown the supply current will drop to $1\mu\text{A}$ immediately.

PACKAGE DESCRIPTION

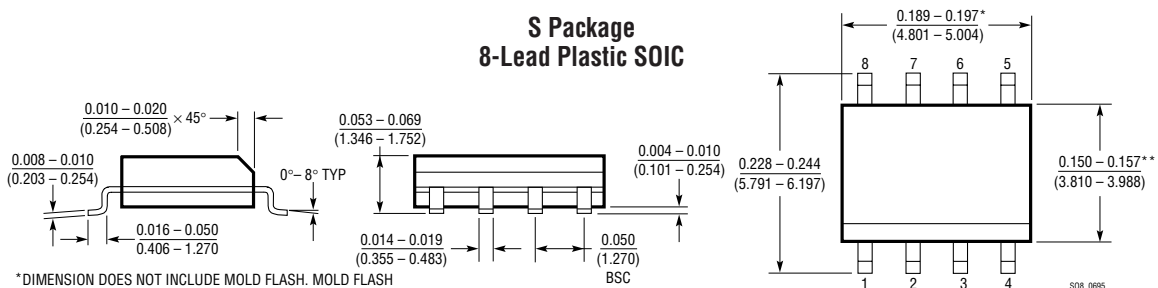
Dimension in inches (millimeters) unless otherwise noted.

N Package 8-Lead Plastic DIP



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

S Package 8-Lead Plastic SOIC



*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
|-------------|---|---|
| LTC485 | 5V Low Power RS485 Interface Transceiver | Low Power |
| LTC1480 | 3.3V Ultra-Low Power RS485 Transceiver | World's First 3V Powered 485 Transceiver with Low Power Consumption |
| LTC1481 | 5V Ultra-Low Power RS485 Transceiver with Shutdown | Lowest Power |
| LTC1485 | 5V Differential Bus Transceiver | Highest Speed |
| LTC1487 | 5V Ultra-Low Power RS485 with Low EMI Shutdown and High Input Impedance | High Input Impedance/Low EMI/Lowest Power |

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